## DATA SHEET



# MOS FIELD EFFECT TRANSISTOR

# 2SK3114

### **SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE**

#### DESCRIPTION

The 2SK3114 is N-channel DMOS FET device that features a low gate charge and excellent switching characteristics, and designed for high voltage applications such as switching power supply, AC adapter.

#### **FEATURES**

• Low on-state resistance:

 $R_{DS(on)} = 2.2 \Omega MAX. (V_{GS} = 10 V, I_D = 2.0 A)$ 

- Low gate charge:
- QG = 15 nC TYP. (VDD = 450 V, VGS = 10 V, ID = 4.0 A)
- Gate voltage rating: ±30 V
- Avalanche capability ratings
- Isolated TO-220 package

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	600	V
Gate to Source Voltage ( $V_{DS} = 0 V$ )	Vgss	±30	V
Drain Current (DC) (Tc = 25°C)	D(DC)	±4.0	А
Drain Current (pulse) <sup>Note1</sup>	D(pulse)	±16	А
Total Power Dissipation (Tc = 25°C)	<b>P</b> T1	30	W
Total Power Dissipation ( $T_A = 25^{\circ}C$ )	<b>P</b> <sub>T2</sub>	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	4.0	А
Single Avalanche Energy <sup>Note2</sup>	Eas	10.7	mJ

#### **Notes 1.** PW $\leq$ 10 $\mu$ s, Duty cycle $\leq$ 1%

**2.** Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = 150 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20  $\rightarrow$  0 V

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#### **ORDERING INFORMATION**

PART NUMBER	PACKAGE
2SK3114	Isolated TO-220

(Isolated TO-220)

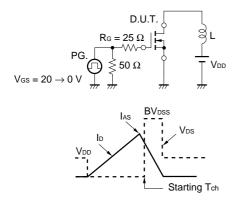


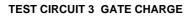
#### ELECTRICAL CHARACTERISTICS (TA = 25°C)

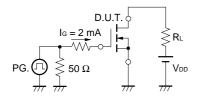
Characteristics	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V			100	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 30 V, V_{DS} = 0 V$			±10	μA
Gate Cut-off Voltage	VGS(off)	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.5		3.5	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 2.0 A	1.0	50		S
Drain to Source On-state Resistance	RDS(on)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2.0 A		1.6	2.2	Ω
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V		550		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		115		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		13		pF
Turn-on Delay Time	td(on)	V <sub>DD</sub> = 150 V, I <sub>D</sub> = 2.0 A		12		ns
Rise Time	tr	V <sub>GS(on)</sub> = 10 V		6		ns
Turn-off Delay Time	td(off)	R <sub>G</sub> = 10 Ω		35		ns
Fall Time	tr	RL = 10 Ω		12		ns
Total Gate Charge	QG	V <sub>DD</sub> = 450 V		15		nC
Gate to Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = 10 V		4		nC
Gate to Drain Charge	Qgd	I <sub>D</sub> = 4.0 A		4.4		nC
Body Diode Forward Voltage	VF(S-D)	I <sub>F</sub> = 4.0 A, V <sub>GS</sub> = 0 V		0.9		V
Reverse Recovery Time	trr	IF = 4.0 A, VGS = 0 V		1.3		μs
Reverse Recovery Charge	Qrr	di/dt = 50 A/ $\mu$ s		4.3		μC

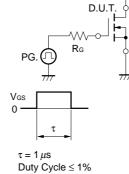
#### TEST CIRCUIT 1 AVALANCHE CAPABILITY

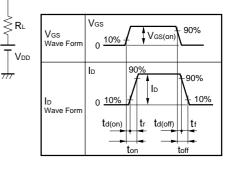
#### **TEST CIRCUIT 2 SWITCHING TIME**



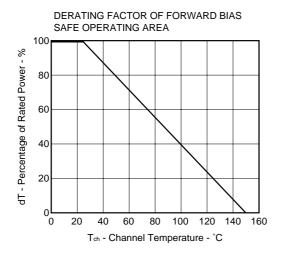




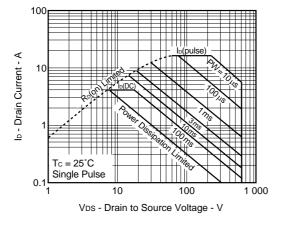


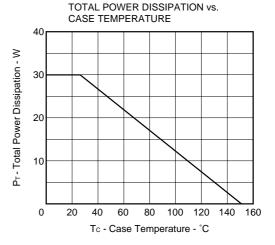


#### TYPICAL CHARACTERISTICS (TA = 25°C )

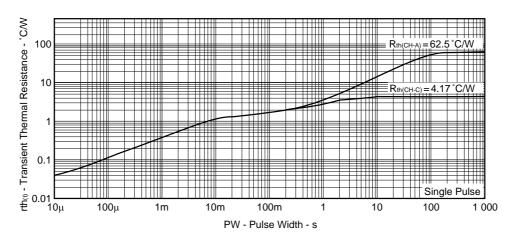


FORWARD BIAS SAFE OPERATING AREA





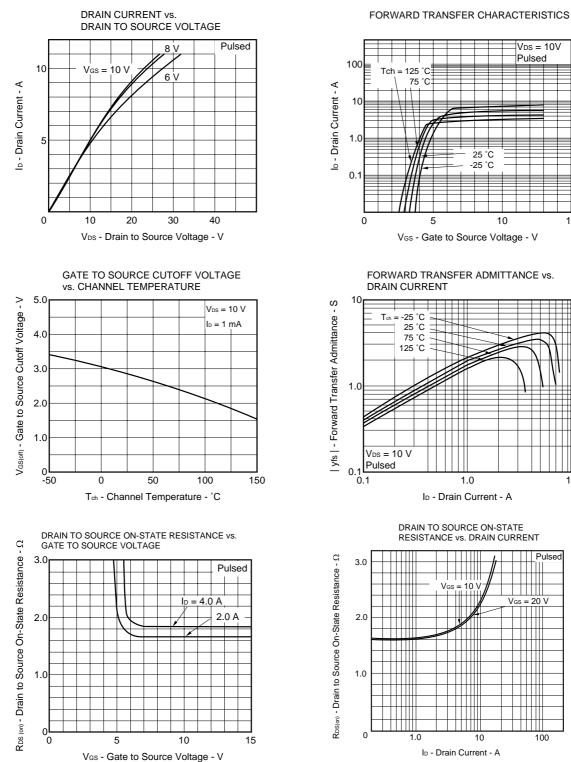
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



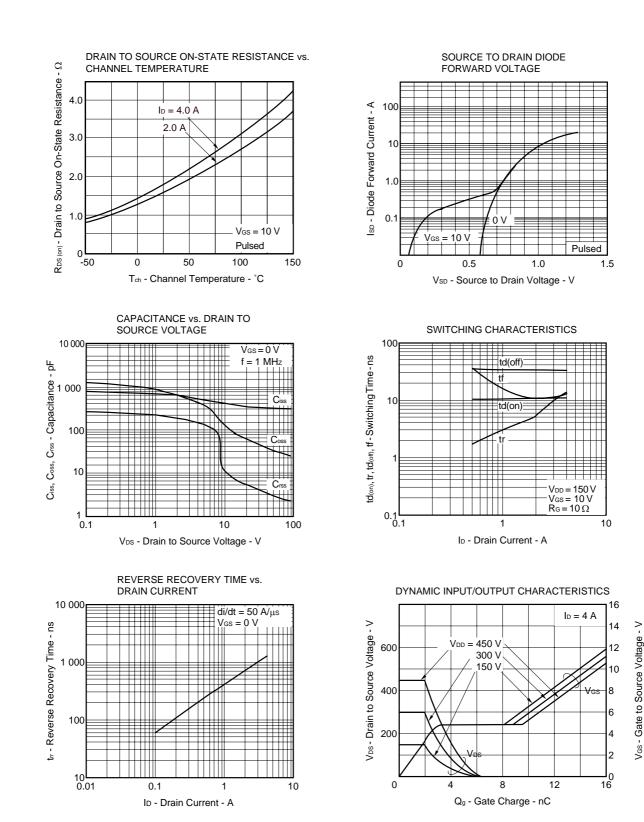
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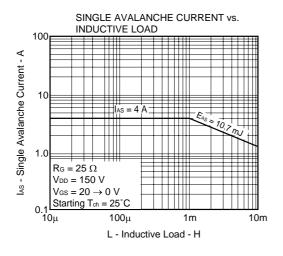
15

10



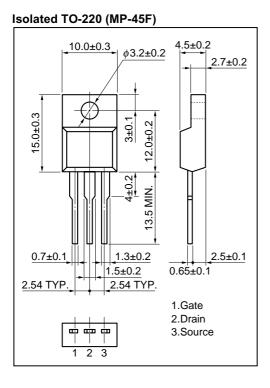
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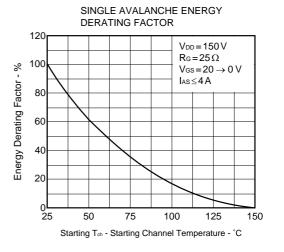




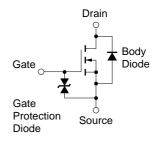
#### PACKAGE DRAWINGS (Unit: mm)

NEC





#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

## NEC

[MEMO]

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